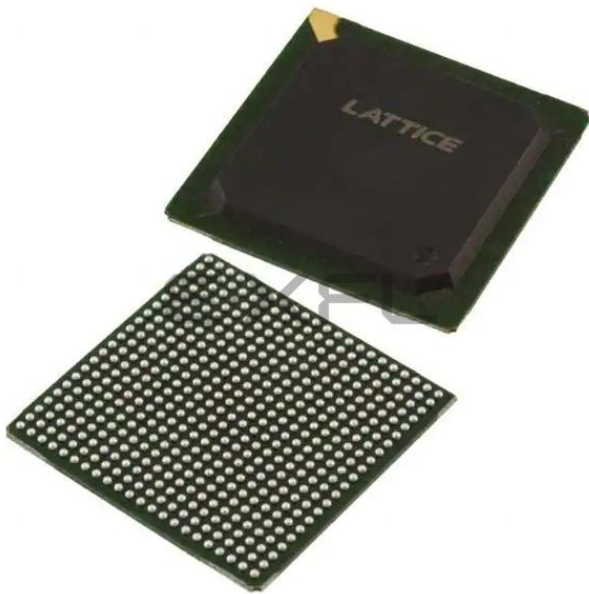




Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

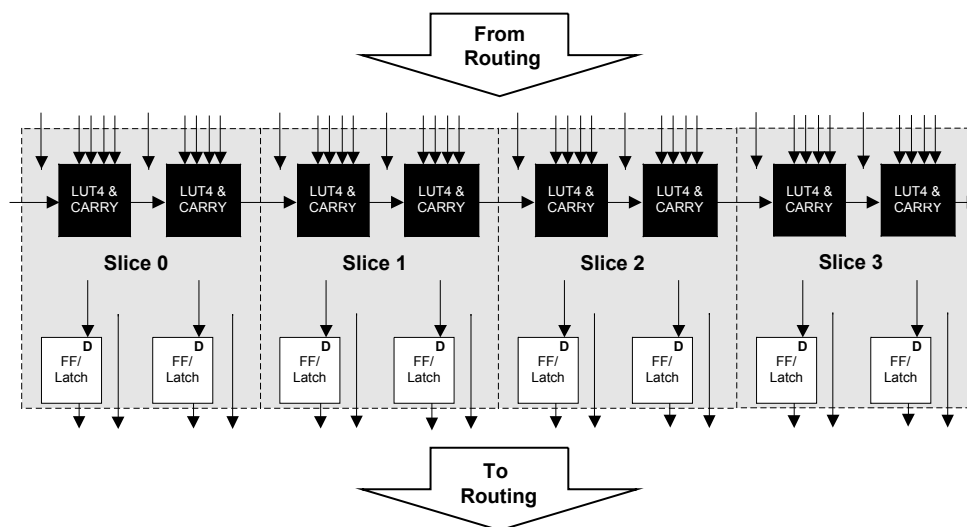
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	32800
Total RAM Bits	434176
Number of I/O	360
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec33e-5fn484c

PFU and PFF Blocks

The core of the LatticeECP/EC devices consists of PFU and PFF blocks. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions. PFF blocks can be programmed to perform Logic, Arithmetic and ROM functions. Except where necessary, the remainder of the data sheet will use the term PFU to refer to both PFU and PFF blocks.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-3. All the interconnections to and from PFU blocks are from routing. There are 53 inputs and 25 outputs associated with each PFU block.

Figure 2-3. PFU Diagram



Slice

Each slice contains two LUT4 lookup tables feeding two registers (programmed to be in FF or Latch mode), and some associated logic that allows the LUTs to be combined to perform functions such as LUT5, LUT6, LUT7 and LUT8. There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-4 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge/level clocks.

There are 14 input signals: 13 signals from routing and one from the carry-chain (from adjacent slice or PFU). There are 7 outputs: 6 to routing and one to carry-chain (to adjacent PFU). Table 2-1 lists the signals associated with each slice.

Routing

There are many resources provided in the LatticeECP/EC devices to route signals individually or as busses with related control signals. The routing resources consist of switching circuitry, buffers and metal interconnect (routing) segments.

The inter-PFU connections are made with x1 (spans two PFU), x2 (spans three PFU) and x6 (spans seven PFU). The x1 and x2 connections provide fast and efficient connections in horizontal and vertical directions. The x2 and x6 resources are buffered, the routing of both short and long connections between PFUs.

The ispLEVER design tool suite takes the output of the synthesis tool and places and routes the design. Generally, the place and route tool is completely automatic, although an interactive routing editor is available to optimize the design.

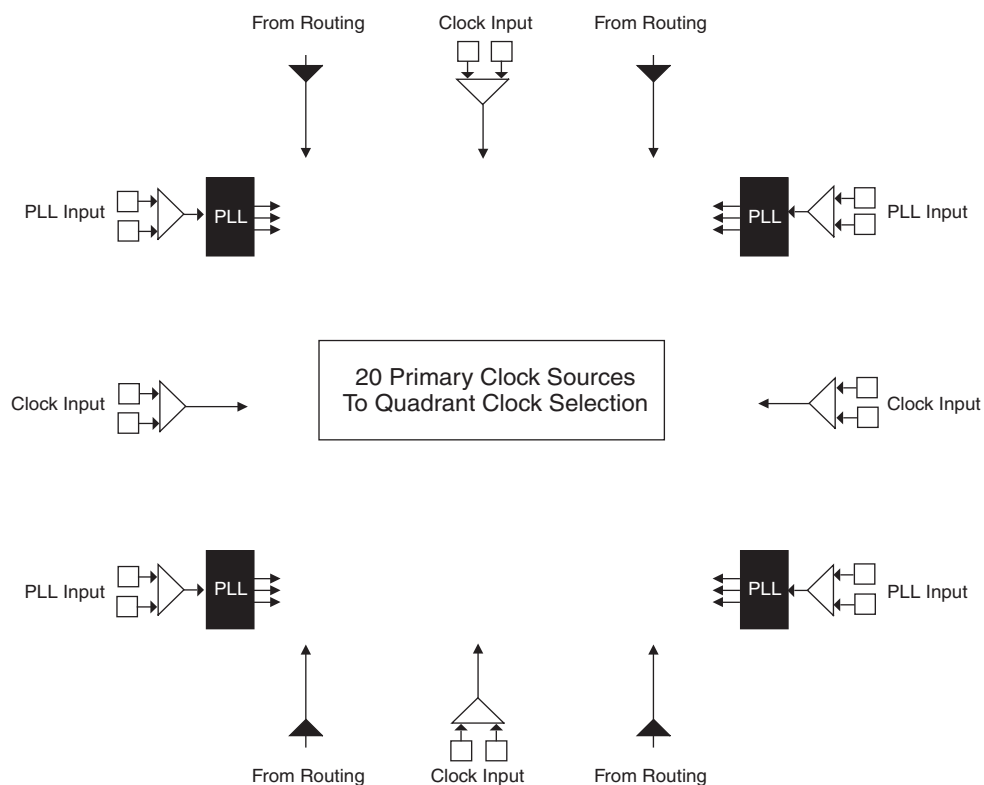
Clock Distribution Network

The clock inputs are selected from external I/O, the sysCLOCK™ PLLs or routing. These clock inputs are fed through the chip via a clock distribution system.

Primary Clock Sources

LatticeECP/EC devices derive clocks from three primary sources: PLL outputs, dedicated clock inputs and routing. LatticeECP/EC devices have two to four sysCLOCK PLLs, located on the left and right sides of the device. There are four dedicated clock inputs, one on each side of the device. Figure 2-6 shows the 20 primary clock sources.

Figure 2-6. Primary Clock Sources



Note: Smaller devices have two PLLs.

Table 2-5. PLL Signal Descriptions

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	PLL feedback input from CLKOP (PLL internal), from clock net (CLKOP) or from a user clock (PIN or logic)
RST	I	"1" to reset PLL
CLKOS	O	PLL output clock to clock tree (phase shifted/duty cycle changed)
CLKOP	O	PLL output clock to clock tree (No phase shift)
CLKOK	O	PLL output to clock tree through secondary clock divider
LOCK	O	"1" indicates PLL LOCK to CLKI
DDAMODE	I	Dynamic Delay Enable. "1": Pin control (dynamic), "0": Fuse Control (static)
DDAIZR	I	Dynamic Delay Zero. "1": delay = 0, "0": delay = on
DDAILAG	I	Dynamic Delay Lag/Lead. "1": Lead, "0": Lag
DDAIDEL[2:0]	I	Dynamic Delay Input
DDAOZR	O	Dynamic Delay Zero Output
DDAOLAG	O	Dynamic Delay Lag/Lead Output
DDAODEL[2:0]	O	Dynamic Delay Output

For more information about the PLL, please see the list of technical documentation at the end of this data sheet.

Dynamic Clock Select (DCS)

The DCS is a global clock buffer with smart multiplexer functions. It takes two independent input clock sources and outputs a clock signal without any glitches or runt pulses. This is achieved regardless of where the select signal is toggled. There are eight DCS blocks per device, located in pairs at the center of each side. Figure 2-13 illustrates the DCS Block Macro.

Figure 2-13. DCS Block Primitive

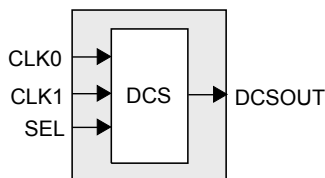


Figure 2-14 shows timing waveforms of the default DCS operating mode. The DCS block can be programmed to other modes. For more information about the DCS, please see the list of technical documentation at the end of this data sheet.

Table 2-7. Maximum Number of Elements in a Block

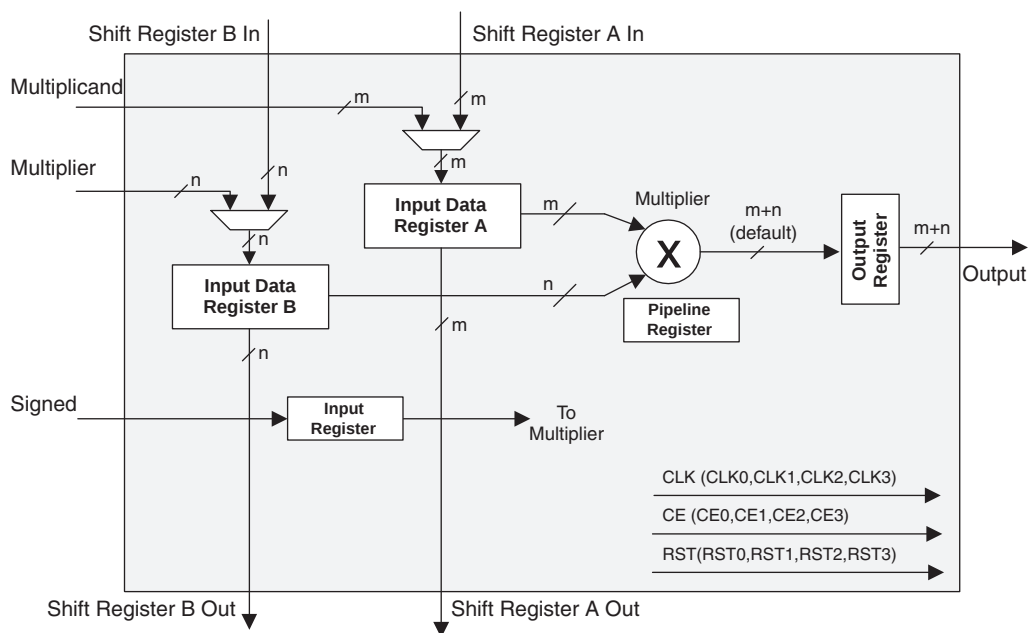
Width of Multiply	x9	x18	x36
MULT	8	4	1
MAC	2	2	—
MULTADD	4	2	—
MULTADDSUM	2	1	—

Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as shift registers from previous operand registers. In addition by selecting “dynamic operation” in the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle. Similarly by selecting ‘Dynamic operation’ in the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.

MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-19 shows the MULT sysDSP element.

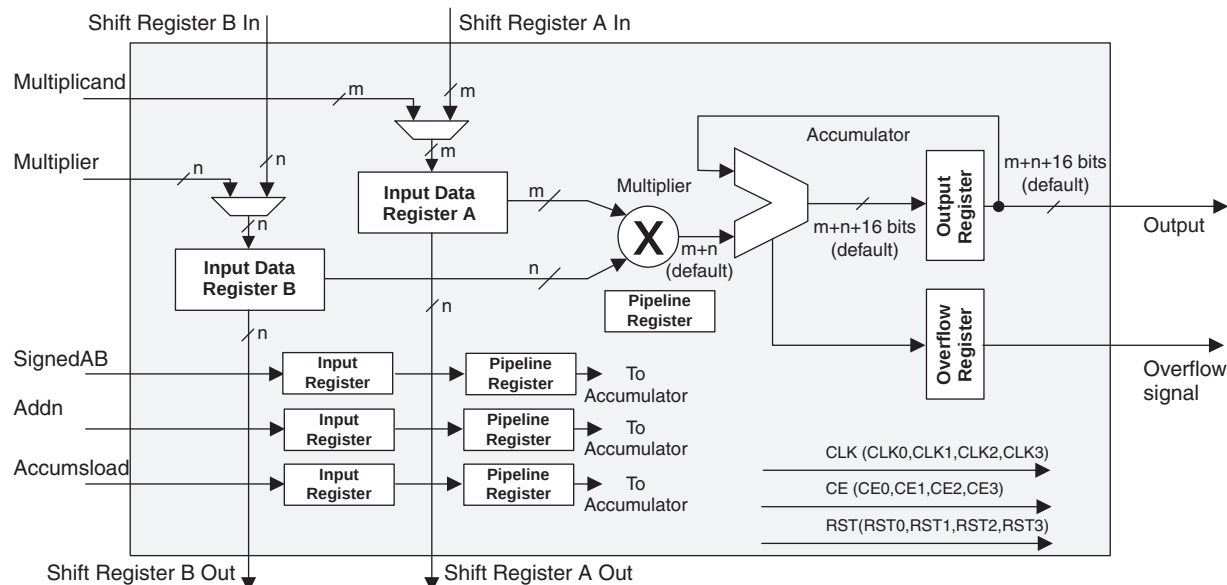
Figure 2-19. MULT sysDSP Element



MAC sysDSP Element

In this case the two operands, A and B, are multiplied and the result is added with the previous accumulated value. This accumulated value is available at the output. The user can enable the input and pipeline registers but the output register is always enabled. The output register is used to store the accumulated value. A registered overflow signal is also available. The overflow conditions are provided later in this document. Figure 2-20 shows the MAC sysDSP element.

Figure 2-20. MAC sysDSP Element



MULTADD sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and A2. The user can enable the input, output and pipeline registers. Figure 2-21 shows the MULTADD sysDSP element.

Figure 2-21. MULTADD

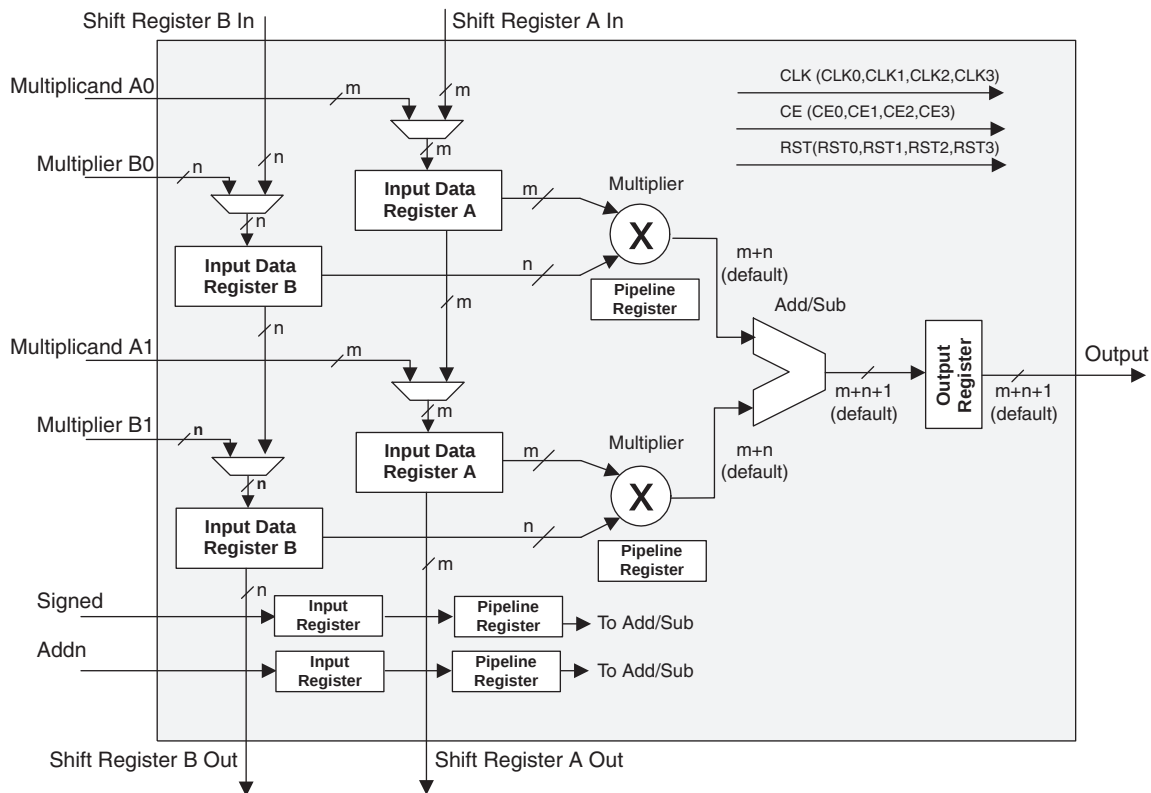
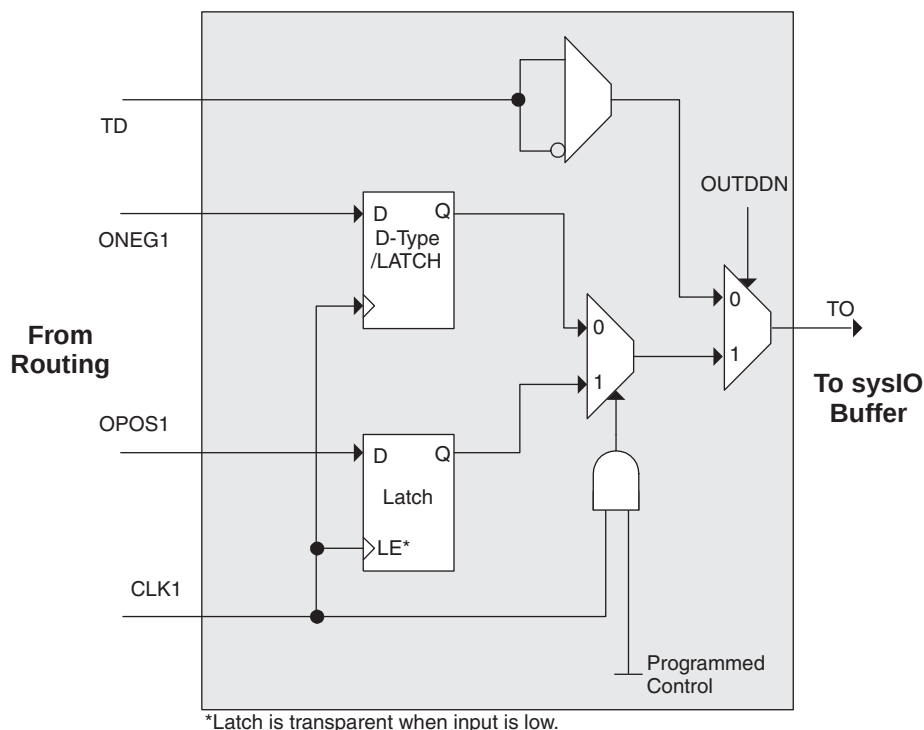


Figure 2-31. Tristate Register Block



Control Logic Block

The control logic block allows the selection and modification of control signals for use in the PIO block. A clock is selected from one of the clock signals provided from the general purpose routing and a DQS signal provided from the programmable DQS pin. The clock can optionally be inverted.

The clock enable and local reset signals are selected from the routing and optionally inverted. The global tristate signal is passed through this block.

DDR Memory Support

Implementing high performance DDR memory interfaces requires dedicated DDR register structures in the input (for read operations) and in the output (for write operations). As indicated in the PIO Logic section, the LatticeEC devices provide this capability. In addition to these registers, the LatticeEC devices contain two elements to simplify the design of input structures for read operations: the DQS delay block and polarity control logic.

DLL Calibrated DQS Delay Block

Source Synchronous interfaces generally require the input clock to be adjusted in order to correctly capture data at the input register. For most interfaces a PLL is used for this adjustment. However in DDR memories the clock (referred to as DQS) is not free running so this approach cannot be used. The DQS Delay block provides the required clock alignment for DDR memory interfaces.

The DQS signal (selected PIOs only) feeds from the PAD through a DQS delay element to a dedicated DQS routing resource. The DQS signal also feeds polarity control logic, which controls the polarity of the clock to the sync registers in the input register blocks. Figures 2-32 and 2-33 show how the DQS transition signals are routed to the PIOs.

The temperature, voltage and process variations of the DQS delay block are compensated by a set of calibration (6-bit bus) signals from two DLLs on opposite sides of the device. Each DLL compensates DQS Delays in its half of the device as shown in Figure 2-33. The DLL loop is compensated for temperature, voltage and process variations by the system clock and feedback loop.

Absolute Maximum Ratings^{1, 2, 3}

Supply Voltage V_{CC}	-0.5 to 1.32V
Supply Voltage V_{CCAUX}	-0.5 to 3.75V
Supply Voltage V_{CCJ}	-0.5 to 3.75V
Output Supply Voltage V_{CCIO}	-0.5 to 3.75V
Dedicated Input Voltage Applied ⁴	-0.5 to 4.25V
I/O Tristate Voltage Applied ⁴	-0.5 to 3.75V
Storage Temperature (Ambient)	-65 to 150°C
Junction Temp. (Tj)	+125°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice *Thermal Management* document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to ($V_{IHMAX} + 2$) volts is permitted for a duration of <20ns.

Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Units
V_{CC}	Core Supply Voltage	1.14	1.26	V
V_{CCAUX}^3	Auxiliary Supply Voltage	3.135	3.465	V
V_{CCPLL}	PLL Supply Voltage for ECP/EC33	1.14	1.26	V
$V_{CCIO}^{1, 2}$	I/O Driver Supply Voltage	1.140	3.465	V
V_{CCJ}^1	Supply Voltage for IEEE 1149.1 Test Access Port	1.140	3.465	V
t_{JCOM}	Junction Commercial Operation	0	85	°C
t_{JIND}	Junction Industrial Operation	-40	100	°C

1. If V_{CCIO} or V_{CCJ} is set to 1.2V, they must be connected to the same power supply as V_{CC} . If V_{CCIO} or V_{CCJ} is set to 3.3V, they must be connected to the same power supply as V_{CCAUX} .
2. See recommended voltages by I/O standard in subsequent table.
3. V_{CCAUX} ramp rate must not exceed 3mV/ μ s for commercial and 0.6 mV/ μ s for industrial device operations during power up when transitioning between 0.8V and 1.8V.

Hot Socketing Specifications^{1, 2, 3, 4}

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Top and Bottom General Purpose sysI/Os (Banks 0, 1, 4 and 5), JTAG and Dedicated sysCONFIG Pins						
I_{DK_TB}	Input or I/O Leakage Current	0 δ V_{IN} δ V_{IH} (MAX.)	—	—	+/-1000	μ A
Left and Right General Purpose sysI/Os (Banks 2, 3, 6 and 7)						
I_{DK_LR}	Input or I/O Leakage Current	$V_{IN} \delta V_{CCIO}$	—	—	+/-1000	μ A
		$V_{IN} > V_{CCIO}$	—	35	—	mA

1. Insensitive to sequence of V_{CC} , V_{CCAUX} and V_{CCIO} . However, assumes monotonic rise/fall rates for V_{CC} , V_{CCAUX} and V_{CCIO} .
2. 0 δ $V_{CC} \delta V_{CC}$ (MAX), 0 δ $V_{CCIO} \delta V_{CCIO}$ (MAX) or 0 δ $V_{CCAUX} \delta V_{CCAUX}$ (MAX).
3. I_{DK} is additive to I_{PU} , I_{PW} or I_{BH} .
4. LVCMOS and LVTTL only.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{IL}, I_{IH}^1	Input or I/O Leakage	$0 \leq V_{IN} \leq (V_{CCIO} - 0.2V)$	—	—	10	μA
$I_{IH}^{1,3}$	Input or I/O High Leakage	$(V_{CCIO} - 0.2V) \leq V_{IH} \leq 3.6V$	—	—	40	μA
I_{PU}	I/O Active Pull-up Current	$0 \leq V_{IN} \leq 0.7 V_{CCIO}$	-30	—	-150	μA
I_{PD}	I/O Active Pull-down Current	$V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MAX)$	30	—	150	μA
I_{BHLS}	Bus Hold Low sustaining current	$V_{IN} = V_{IL} (MAX)$	30	—	—	μA
I_{BHHS}	Bus Hold High sustaining current	$V_{IN} = 0.7V_{CCIO}$	-30	—	—	μA
I_{BHLO}	Bus Hold Low Overdrive current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	150	μA
I_{BHLH}	Bus Hold High Overdrive current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	-150	μA
V_{BHT}	Bus Hold trip Points	$0 \leq V_{IN} \leq V_{IH} (MAX)$	$V_{IL} (MAX)$	—	$V_{IH} (MIN)$	V
C1	I/O Capacitance ²	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	8	—	pf
C2	Dedicated Input Capacitance ²	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

2. T_A 25°C, $f = 1.0MHz$

3. For top and bottom general purpose I/O pins, when V_{IH} is higher than V_{CCIO} , a transient current typically of 30ns in duration or less with a peak current of 6mA can occur on the high-to-low transition. For left and right I/O banks, V_{IH} must be less than or equal to V_{CCIO} .

Supply Current (Standby)^{1, 2, 3, 4}

Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ⁵	Units
I_{CC}	Core Power Supply Current	LFEC1	6	mA
		LFEC3	10	mA
		LFEC6/LFEC6	15	mA
		LFEC10/LFEC10	25	mA
		LFEC15/LFEC15	35	mA
		LFEC20/LFEC20	60	mA
		LFEC33/LFEC33	85	mA
I_{CCAUX}	Auxiliary Power Supply Current		15	mA
I_{CCPLL}	PLL Power Supply Current		5	mA
I_{CCIO}	Bank Power Supply Current ⁶		2	mA
I_{CCJ}	V_{CCJ} Power Supply Current		5	mA

1. For further information about supply current, please see the list of technical documentation at the end of this data sheet.
2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
3. Frequency 0MHz.
4. Pattern represents a "blank" configuration data file.
5. $T_J=25^{\circ}\text{C}$, power supplies at nominal voltage.
6. Per bank.

Derating Timing Tables

Logic Timing provided in the following sections of the data sheet and the ispLEVER design tools are worst-case numbers in the operating range. Actual delays at nominal temperature and voltage for best-case process, can be much better than the values given in the tables. To calculate logic timing numbers at a particular temperature and voltage multiply the noted numbers with the derating factors provided below.

The junction temperature for the FPGA depends on the power dissipation by the device, the package thermal characteristics (Θ_{JA}), and the ambient temperature, as calculated with the following equation:

$$T_{JMAX} = T_{AMAX} + (\text{Power} * \Theta_{JA})$$

The user must determine this temperature and then use it to determine the derating factor based on the following derating tables: T_J °C.

Table 3-5. Delay Derating Table for Internal Blocks

T_J °C Commercial	T_J °C Industrial	Power Supply Voltage		
		1.14V	1.2V	1.26V
—	-40	0.82	0.77	0.71
—	-25	0.82	0.76	0.71
0	20	0.89	0.83	0.78
25	45	0.93	0.87	0.81
85	105	1.00	0.94	0.89

LatticeECP/EC Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	-5		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t_{SUC_EBR}	Clock Enable Setup Time to EBR Output Register	0.18	—	0.21	—	0.25	—	ns
t_{HCE_EBR}	Clock Enable Hold Time to EBR Output Register	-0.14	—	-0.17	—	-0.20	—	ns
t_{RSTO_EBR}	Reset To Output Delay Time from EBR Output Register	—	1.47	—	1.76	—	2.05	ns
PLL Parameters								
t_{RSTREC}	Reset Recovery to Rising Clock	1.00	—	1.00	—	1.00	—	ns
t_{RSTSU}	Reset Signal Setup Time	1.00	—	1.00	—	1.00	—	ns
DSP Block Timing^{2,3}								
t_{SUI_DSP}	Input Register Setup Time	-0.38	—	-0.30	—	-0.23	—	ns
t_{HI_DSP}	Input Register Hold Time	0.71	—	0.86	—	1.00	—	ns
t_{SUP_DSP}	Pipeline Register Setup Time	3.31	—	3.98	—	4.64	—	ns
t_{HP_DSP}	Pipeline Register Hold Time	0.71	—	0.86	—	1.00	—	ns
$t_{SUO_DSP}^4$	Output Register Setup Time	5.54	—	6.64	—	7.75	—	ns
$t_{HO_DSP}^4$	Output Register Hold Time	0.71	—	0.86	—	1.00	—	ns
$t_{COI_DSP}^4$	Input Register Clock to Output Time	—	7.50	—	9.00	—	10.50	ns
$t_{COP_DSP}^4$	Pipeline Register Clock to Output Time	—	4.66	—	5.60	—	6.53	ns
t_{COO_DSP}	Output Register Clock to Output Time	—	1.47	—	1.77	—	2.06	ns
$t_{SUADSUB}$	AdSub Input Register Setup Time	-0.38	—	-0.30	—	-0.23	—	ns
t_{HADSUB}	AdSub Input Register Hold Time	0.71	—	0.86	—	1.00	—	ns

1. Internal parameters are characterized but not tested on every device.

2. These parameters apply to LatticeECP devices only.

3. DSP Block is configured in Multiply Add/Sub 18 x 18 Mode.

4. These parameters include the Adder Subtractor block in the path.

Timing v.G 0.30

LatticeECP/EC Family Timing Adders^{1, 2, 3} (Continued)

Over Recommended Operating Conditions

Buffer Type	Description	-5	-4	-3	Units
HSTL15_II	HSTL_15 class II	0.10	0.12	0.14	ns
HSTL15_III	HSTL_15 class III	0.10	0.12	0.14	ns
HSTL15D_I	Differential HSTL 15 class I	0.08	0.10	0.11	ns
HSTL15D_III	Differential HSTL 15 class III	0.10	0.12	0.14	ns
SSTL33_I	SSTL_3 class I	-0.05	-0.06	-0.07	ns
SSTL33_II	SSTL_3 class II	0.40	0.48	0.56	ns
SSTL33D_I	Differential SSTL_3 class I	-0.05	-0.06	-0.07	ns
SSTL33D_II	Differential SSTL_3 class II	0.40	0.48	0.56	ns
SSTL25_I	SSTL_2 class I	0.05	0.07	0.08	ns
SSTL25_II	SSTL_2 class II	0.25	0.30	0.35	ns
SSTL25D_I	Differential SSTL_2 class I	0.05	0.07	0.08	ns
SSTL25D_II	Differential SSTL_2 class II	0.25	0.30	0.35	ns
SSTL18_I	SSTL_1.8 class I	0.01	0.01	0.01	ns
SSTL18D_I	Differential SSTL_1.8 class I	0.01	0.01	0.01	ns
LVTTTL33_4mA	LVTTTL 4mA drive	0.09	0.11	0.13	ns
LVTTTL33_8mA	LVTTTL 8mA drive	0.07	0.08	0.09	ns
LVTTTL33_12mA	LVTTTL 12mA drive	-0.03	-0.04	-0.05	ns
LVTTTL33_16mA	LVTTTL 16mA drive	0.36	0.43	0.51	ns
LVTTTL33_20mA	LVTTTL 20mA drive	0.28	0.33	0.39	ns
LVC MOS33_4mA	LVC MOS 3.3 4mA drive	0.09	0.11	0.13	ns
LVC MOS33_8mA	LVC MOS 3.3 8mA drive	0.07	0.08	0.09	ns
LVC MOS33_12mA	LVC MOS 3.3 12mA drive	-0.03	-0.04	-0.05	ns
LVC MOS33_16mA	LVC MOS 3.3 16mA drive	0.36	0.43	0.51	ns
LVC MOS33_20mA	LVC MOS 3.3 20mA drive	0.28	0.33	0.39	ns
LVC MOS25_4mA	LVC MOS 2.5 4mA drive	0.18	0.21	0.25	ns
LVC MOS25_8mA	LVC MOS 2.5 8mA drive	0.10	0.12	0.14	ns
LVC MOS25_12mA	LVC MOS 2.5 12mA drive	0.00	0.00	0.00	ns
LVC MOS25_16mA	LVC MOS 2.5 16mA drive	0.22	0.26	0.31	ns
LVC MOS25_20mA	LVC MOS 2.5 20mA drive	0.14	0.16	0.19	ns
LVC MOS18_4mA	LVC MOS 1.8 4mA drive	0.15	0.18	0.21	ns
LVC MOS18_8mA	LVC MOS 1.8 8mA drive	0.06	0.08	0.09	ns
LVC MOS18_12mA	LVC MOS 1.8 12mA drive	0.01	0.01	0.01	ns
LVC MOS18_16mA	LVC MOS 1.8 16mA drive	0.16	0.19	0.22	ns
LVC MOS15_4mA	LVC MOS 1.5 4mA drive	0.26	0.31	0.36	ns
LVC MOS15_8mA	LVC MOS 1.5 8mA drive	0.04	0.04	0.05	ns
LVC MOS12_2mA	LVC MOS 1.2 2mA drive	0.36	0.43	0.50	ns
LVC MOS12_6mA	LVC MOS 1.2 6mA drive	0.08	0.10	0.11	ns
LVC MOS12_4mA	LVC MOS 1.2 4mA drive	0.36	0.43	0.50	ns
PCI33	PCI33	1.05	1.26	1.46	ns

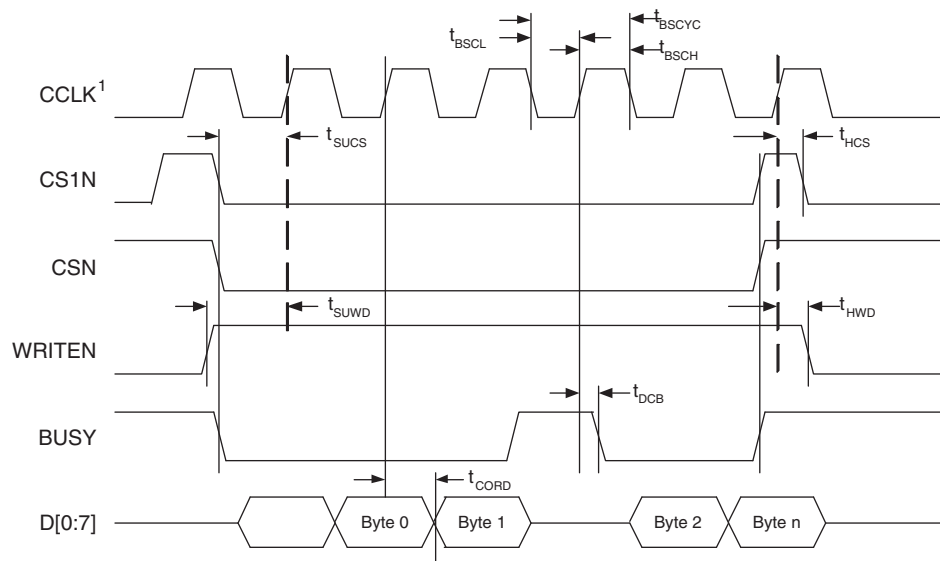
1. Timing adders are characterized but not tested on every device.

2. LVC MOS timing measured with the load specified in Switching Test Conditions table of this document.

3. All other standards according to the appropriate specification.

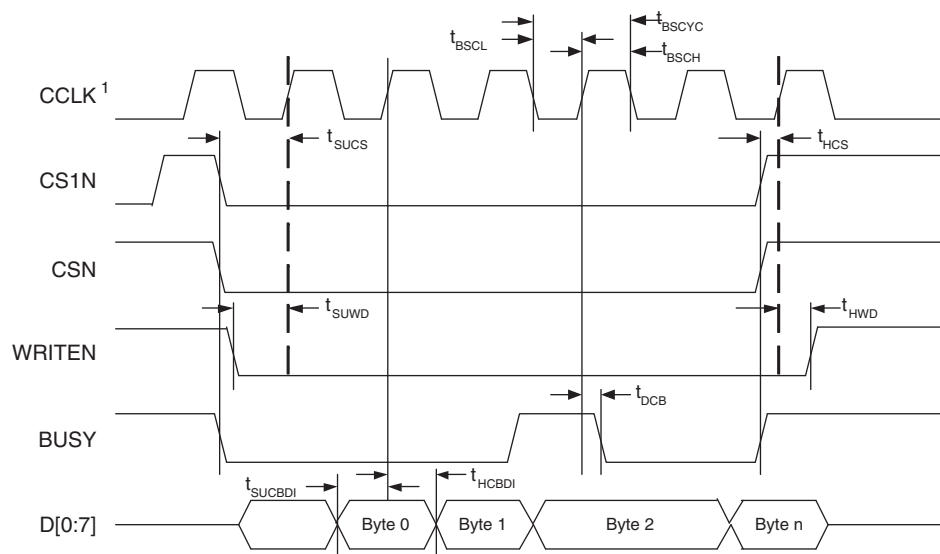
Timing v.G 0.30

Figure 3-12. sysCONFIG Parallel Port Read Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Figure 3-13. sysCONFIG Parallel Port Write Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
C16	PR4B	2	C		PR4B	2	C	
B16	PR4A	2	T		PR4A	2	T	
C15	PR3B	2	C		PR3B	2	C	
C14	PR3A	2	T		PR3A	2	T	
D14	PR2B	2	C	VREF1_2	PR2B	2	C	VREF1_2
D13	PR2A	2	T	VREF2_2	PR2A	2	T	VREF2_2
GND	GND2	2			GND2	2		
GND	GND1	1			GND1	1		
-	-	-			GND1	1		
B13	NC	-			PT26B	1	C	
C13	NC	-			PT26A	1	T	
C12	PT25B	1	C		PT25B	1	C	
-	-	-			GND1	1		
D12	PT25A	1	T		PT25A	1	T	
A15	PT24B	1	C		PT24B	1	C	
B14	PT24A	1	T		PT24A	1	T	
D11	PT23B	1	C		PT23B	1	C	
C11	PT23A	1	T		PT23A	1	T	
E10	PT22B	1	C		PT22B	1	C	
E11	PT22A	1	T	TDQS22	PT22A	1	T	TDQS22
A14	PT21B	1	C		PT21B	1	C	
GND	GND1	1			GND1	1		
A13	PT21A	1	T		PT21A	1	T	
D10	PT20B	1	C		PT20B	1	C	
C10	PT20A	1	T		PT20A	1	T	
A12	PT19B	1	C	VREF2_1	PT19B	1	C	VREF2_1
B12	PT19A	1	T	VREF1_1	PT19A	1	T	VREF1_1
A11	PT18B	1	C		PT18B	1	C	
B11	PT18A	1	T		PT18A	1	T	
A10	PT17B	0	C	PCLKC0_0	PT17B	0	C	PCLKC0_0
GND	GND0	0			GND0	0		
B10	PT17A	0	T	PCLKT0_0	PT17A	0	T	PCLKT0_0
C9	PT16B	0	C	VREF1_0	PT16B	0	C	VREF1_0
B9	PT16A	0	T	VREF2_0	PT16A	0	T	VREF2_0
E9	PT15B	0	C		PT15B	0	C	
D9	PT15A	0	T		PT15A	0	T	
D8	PT14B	0	C		PT14B	0	C	
C8	PT14A	0	T	TDQS14	PT14A	0	T	TDQS14
A9	PT13B	0	C		PT13B	0	C	
GND	GND0	0			GND0	0		
A8	PT13A	0	T		PT13A	0	T	
B8	PT12B	0	C		PT12B	0	C	
B7	PT12A	0	T		PT12A	0	T	

LFEC6P/EC6, LFEC6P/EC10, LFEC6P/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC6P/EC6					LFEC6P/EC10					LFEC6P/EC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
M4	PL13A	6	T		M4	PL22A	6	T		M4	PL26A	6	T	
M5	PL13B	6	C		M5	PL22B	6	C		M5	PL26B	6	C	
M1	PL14A	6	T		M1	PL23A	6	T		M1	PL27A	6	T	
GND	GND6	6			GND	GND6	6			GND	GND6	6		
M2	PL14B	6	C		M2	PL23B	6	C		M2	PL27B	6	C	
N3	PL15A	6	T	LDQS15	N3	PL24A	6	T	LDQS24	N3	PL28A	6	T	LDQS28
M3	PL15B	6	C		M3	PL24B	6	C		M3	PL28B	6	C	
N5	PL16A	6	T		N5	PL25A	6	T		N5	PL29A	6	T	
N4	PL16B	6	C		N4	PL25B	6	C		N4	PL29B	6	C	
N1	PL17A	6	T		N1	PL26A	6	T		N1	PL30A	6	T	
N2	PL17B	6	C		N2	PL26B	6	C		N2	PL30B	6	C	
P1	PL18A	6	T		P1	PL27A	6	T		P1	PL31A	6	T	
GND	GND6	6			GND	GND6	6			GND	GND6	6		
P2	PL18B	6	C		P2	PL27B	6	C		P2	PL31B	6	C	
R6	NC	-			R6	NC	-			R6	PL32A	6	T	
P5	NC	-			P5	NC	-			P5	PL32B	6	C	
P3	NC	-			P3	NC	-			P3	PL33A	6	T	
P4	NC	-			P4	NC	-			P4	PL33B	6	C	
R1	NC	-			R1	NC	-			R1	PL34A	6	T	
R2	NC	-			R2	NC	-			R2	PL34B	6	C	
R5	NC	-			R5	NC	-			R5	PL35A	6	T	
GND	-	-			-	-	-			GND	GND6	6		
R4	NC	-			R4	NC	-			R4	PL35B	6	C	
T1	NC	-			T1	NC	-			T1	NC	-		
T2	NC	-			T2	NC	-			T2	NC	-		
R3	NC	-			R3	NC	-			R3	NC	-		
T3	NC	-			T3	NC	-			T3	NC	-		
T5	TCK	6			T5	TCK	6			T5	TCK	6		
U5	TDI	6			U5	TDI	6			U5	TDI	6		
T4	TMS	6			T4	TMS	6			T4	TMS	6		
U1	TDO	6			U1	TDO	6			U1	TDO	6		
U2	VCCJ	6			U2	VCCJ	6			U2	VCCJ	6		
V1	PL20A	6	T	LLM0_PLLT_IN_A	V1	PL29A	6	T	LLM0_PLLT_IN_A	V1	PL37A	6	T	LLM0_PLLT_IN_A
V2	PL20B	6	C	LLM0_PLLC_IN_A	V2	PL29B	6	C	LLM0_PLLC_IN_A	V2	PL37B	6	C	LLM0_PLLC_IN_A
U3	PL21A	6	T	LLM0_PLLT_FB_A	U3	PL30A	6	T	LLM0_PLLT_FB_A	U3	PL38A	6	T	LLM0_PLLT_FB_A
V3	PL21B	6	C	LLM0_PLLC_FB_A	V3	PL30B	6	C	LLM0_PLLC_FB_A	V3	PL38B	6	C	LLM0_PLLC_FB_A
U4	PL22A	6	T		U4	PL31A	6	T		U4	PL39A	6	T	
V5	PL22B	6	C		V5	PL31B	6	C		V5	PL39B	6	C	
W1	PL23A	6	T		W1	PL32A	6	T		W1	PL40A	6	T	
GND	GND6	6			GND	GND6	6			GND	GND6	6		
W2	PL23B	6	C		W2	PL32B	6	C		W2	PL40B	6	C	
Y1	PL24A	6	T	LDQS24	Y1	PL33A	6	T	LDQS33	Y1	PL41A	6	T	LDQS41
Y2	PL24B	6	C		Y2	PL33B	6	C		Y2	PL41B	6	C	
AA1	PL25A	6	T		AA1	PL34A	6	T		AA1	PL42A	6	T	
AA2	PL25B	6	C		AA2	PL34B	6	C		AA2	PL42B	6	C	
W4	PL26A	6	T		W4	PL35A	6	T		W4	PL43A	6	T	
V4	PL26B	6	C		V4	PL35B	6	C		V4	PL43B	6	C	
W3	PL27A	6	T	VREF1_6	W3	PL36A	6	T	VREF1_6	W3	PL44A	6	T	VREF1_6
Y3	PL27B	6	C	VREF2_6	Y3	PL36B	6	C	VREF2_6	Y3	PL44B	6	C	VREF2_6
GND	GND6	6			GND	GND6	6			GND	GND6	6		

LFEC6/EC6, LFEC6/EC10, LFEC6/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC6/LFEC6					LFEC10/LFEC10					LFEC6/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
V12	PB16B	5	C	VREF1_5	V12	PB24B	5	C	VREF1_5	V12	PB24B	5	C	VREF1_5
AB10	PB17A	5	T	PCLKT5_0	AB10	PB25A	5	T	PCLKT5_0	AB10	PB25A	5	T	PCLKT5_0
GND	GND5	5			GND	GND5	5			GND	GND5	5		
AB11	PB17B	5	C	PCLKC5_0	AB11	PB25B	5	C	PCLKC5_0	AB11	PB25B	5	C	PCLKC5_0
Y12	PB18A	4	T	WRITEN	Y12	PB26A	4	T	WRITEN	Y12	PB26A	4	T	WRITEN
U11	PB18B	4	C	CS1N	U11	PB26B	4	C	CS1N	U11	PB26B	4	C	CS1N
W12	PB19A	4	T	VREF1_4	W12	PB27A	4	T	VREF1_4	W12	PB27A	4	T	VREF1_4
U12	PB19B	4	C	CSN	U12	PB27B	4	C	CSN	U12	PB27B	4	C	CSN
W13	PB20A	4	T	VREF2_4	W13	PB28A	4	T	VREF2_4	W13	PB28A	4	T	VREF2_4
U13	PB20B	4	C	D0/SPID7	U13	PB28B	4	C	D0/SPID7	U13	PB28B	4	C	D0/SPID7
AA12	PB21A	4	T	D2/SPID5	AA12	PB29A	4	T	D2/SPID5	AA12	PB29A	4	T	D2/SPID5
GND	GND4	4			GND	GND4	4			GND	GND4	4		
AB12	PB21B	4	C	D1/SPID6	AB12	PB29B	4	C	D1/SPID6	AB12	PB29B	4	C	D1/SPID6
T13	PB22A	4	T	BDQS22	T13	PB30A	4	T	BDQS30	T13	PB30A	4	T	BDQS30
V13	PB22B	4	C	D3/SPID4	V13	PB30B	4	C	D3/SPID4	V13	PB30B	4	C	D3/SPID4
W14	PB23A	4	T		W14	PB31A	4	T		W14	PB31A	4	T	
U14	PB23B	4	C	D4/SPID3	U14	PB31B	4	C	D4/SPID3	U14	PB31B	4	C	D4/SPID3
Y13	PB24A	4	T		Y13	PB32A	4	T		Y13	PB32A	4	T	
V14	PB24B	4	C	D5/SPID2	V14	PB32B	4	C	D5/SPID2	V14	PB32B	4	C	D5/SPID2
AA13	PB25A	4	T		AA13	PB33A	4	T		AA13	PB33A	4	T	
GND	GND4	4			GND	GND4	4			GND	GND4	4		
AB13	PB25B	4	C	D6/SPID1	AB13	PB33B	4	C	D6/SPID1	AB13	PB33B	4	C	D6/SPID1
AA14	PB26A	4	T		AA14	PB34A	4	T		AA14	PB34A	4	T	
Y14	PB26B	4	C		Y14	PB34B	4	C		Y14	PB34B	4	C	
Y15	PB27A	4	T		Y15	PB35A	4	T		Y15	PB35A	4	T	
W15	PB27B	4	C		W15	PB35B	4	C		W15	PB35B	4	C	
V15	PB28A	4	T		V15	PB36A	4	T		V15	PB36A	4	T	
T14	PB28B	4	C		T14	PB36B	4	C		T14	PB36B	4	C	
AB14	PB29A	4	T		AB14	PB37A	4	T		AB14	PB37A	4	T	
GND	GND4	4			GND	GND4	4			GND	GND4	4		
AB15	PB29B	4	C		AB15	PB37B	4	C		AB15	PB37B	4	C	
AB16	PB30A	4	T	BDQS30	AB16	PB38A	4	T	BDQS38	AB16	PB38A	4	T	BDQS38
AA15	PB30B	4	C		AA15	PB38B	4	C		AA15	PB38B	4	C	
AB17	PB31A	4	T		AB17	PB39A	4	T		AB17	PB39A	4	T	
AA16	PB31B	4	C		AA16	PB39B	4	C		AA16	PB39B	4	C	
AB18	PB32A	4	T		AB18	PB40A	4	T		AB18	PB40A	4	T	
AA17	PB32B	4	C		AA17	PB40B	4	C		AA17	PB40B	4	C	
AB19	PB33A	4	T		AB19	PB41A	4	T		AB19	PB41A	4	T	
GND	-	-			GND	-	-			GND	GND4	4		
AA18	PB33B	4	C		AA18	PB41B	4	C		AA18	PB41B	4	C	
W16	NC	-			W16	NC	-			W16	PB42A	4	T	
U15	NC	-			U15	NC	-			U15	PB42B	4	C	
V16	NC	-			V16	NC	-			V16	PB43A	4	T	
U16	NC	-			U16	NC	-			U16	PB43B	4	C	
Y17	NC	-			Y17	NC	-			Y17	PB44A	4	T	
V17	NC	-			V17	NC	-			V17	PB44B	4	C	
AB20	NC	-			AB20	NC	-			AB20	PB45A	4	T	
GND	-	-			GND	-	-			GND	GND4	4		
AA19	NC	-			AA19	NC	-			AA19	PB45B	4	C	
Y16	NC	-			Y16	NC	-			Y16	PB46A	4	T	BDQS46

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/LFEC20					LFEC20/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
A7	PT27B	0	C		A7	PT27B	0	C	
A6	PT27A	0	T		A6	PT27A	0	T	
B7	PT26B	0	C		B7	PT26B	0	C	
B8	PT26A	0	T		B8	PT26A	0	T	
A5	PT25B	0	C		A5	PT25B	0	C	
GND	GND0	0			GND	GND0	0		
B6	PT25A	0	T		B6	PT25A	0	T	
G10	PT24B	0	C		G10	PT24B	0	C	
E10	PT24A	0	T		E10	PT24A	0	T	
F10	PT23B	0	C		F10	PT23B	0	C	
D10	PT23A	0	T		D10	PT23A	0	T	
G9	PT22B	0	C		G9	PT22B	0	C	
E9	PT22A	0	T	TDQS22	E9	PT22A	0	T	TDQS22
C9	PT21B	0	C		C9	PT21B	0	C	
GND	GND0	0			GND	GND0	0		
C8	PT21A	0	T		C8	PT21A	0	T	
F9	PT20B	0	C		F9	PT20B	0	C	
D9	PT20A	0	T		D9	PT20A	0	T	
F8	PT19B	0	C		F8	PT19B	0	C	
D7	PT19A	0	T		D7	PT19A	0	T	
D8	PT18B	0	C		D8	PT18B	0	C	
C7	PT18A	0	T		C7	PT18A	0	T	
GND	GND0	0			GND	GND0	0		
A4	PT17B	0	C		A4	PT17B	0	C	
B4	PT17A	0	T		B4	PT17A	0	T	
C4	PT16B	0	C		C4	PT16B	0	C	
C5	PT16A	0	T		C5	PT16A	0	T	
D6	PT15B	0	C		D6	PT15B	0	C	
B5	PT15A	0	T		B5	PT15A	0	T	
E6	PT14B	0	C		E6	PT14B	0	C	
C6	PT14A	0	T	TDQS14	C6	PT14A	0	T	TDQS14
A3	PT13B	0	C		A3	PT13B	0	C	
GND	GND0	0			GND	GND0	0		
B3	PT13A	0	T		B3	PT13A	0	T	
F6	PT12B	0	C		F6	PT12B	0	C	
D5	PT12A	0	T		D5	PT12A	0	T	
F7	PT11B	0	C		F7	PT11B	0	C	
E8	PT11A	0	T		E8	PT11A	0	T	
G6	PT10B	0	C		G6	PT10B	0	C	
E7	PT10A	0	T		E7	PT10A	0	T	
GND	GND0	0			GND	GND0	0		
GND	GND0	0			GND	GND0	0		
A1	GND	-			A1	GND	-		
A22	GND	-			A22	GND	-		

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFEC20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A21	PT51A	1	T		A21	PT51A	1	T	
E17	PT50B	1	C		E17	PT50B	1	C	
B17	PT50A	1	T		B17	PT50A	1	T	
C17	PT49B	1	C		C17	PT49B	1	C	
GND	GND1	1			GND	GND1	1		
D17	PT49A	1	T		D17	PT49A	1	T	
F17	PT48B	1	C		F17	PT48B	1	C	
E20	PT48A	1	T		E20	PT48A	1	T	
G17	PT47B	1	C		G17	PT47B	1	C	
B20	PT47A	1	T		B20	PT47A	1	T	
E16	PT46B	1	C		E16	PT46B	1	C	
A20	PT46A	1	T	TDQS46	A20	PT46A	1	T	TDQS46
A19	PT45B	1	C		A19	PT45B	1	C	
GND	GND1	1			GND	GND1	1		
B19	PT45A	1	T		B19	PT45A	1	T	
D16	PT44B	1	C		D16	PT44B	1	C	
C16	PT44A	1	T		C16	PT44A	1	T	
F16	PT43B	1	C		F16	PT43B	1	C	
A18	PT43A	1	T		A18	PT43A	1	T	
G16	PT42B	1	C		G16	PT42B	1	C	
B18	PT42A	1	T		B18	PT42A	1	T	
A17	PT41B	1	C		A17	PT41B	1	C	
GND	GND1	1			GND	GND1	1		
A16	PT41A	1	T		A16	PT41A	1	T	
D15	PT40B	1	C		D15	PT40B	1	C	
B16	PT40A	1	T		B16	PT40A	1	T	
E15	PT39B	1	C		E15	PT39B	1	C	
C15	PT39A	1	T		C15	PT39A	1	T	
F15	PT38B	1	C		F15	PT38B	1	C	
G15	PT38A	1	T	TDQS38	G15	PT38A	1	T	TDQS38
B15	PT37B	1	C		B15	PT37B	1	C	
GND	GND1	1			GND	GND1	1		
A15	PT37A	1	T		A15	PT37A	1	T	
E14	PT36B	1	C		E14	PT36B	1	C	
G14	PT36A	1	T		G14	PT36A	1	T	
D14	PT35B	1	C	VREF2_1	D14	PT35B	1	C	VREF2_1
E13	PT35A	1	T	VREF1_1	E13	PT35A	1	T	VREF1_1
F14	PT34B	1	C		F14	PT34B	1	C	
C14	PT34A	1	T		C14	PT34A	1	T	
B14	PT33B	0	C	PCLKC0_0	B14	PT33B	0	C	PCLKC0_0
GND	GND0	0			GND	GND0	0		
A14	PT33A	0	T	PCLKT0_0	A14	PT33A	0	T	PCLKT0_0

Conventional Packaging
LatticeEC Commercial

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC1E-3Q208C	112	-3	PQFP	208	COM	1.5K
LFEC1E-4Q208C	112	-4	PQFP	208	COM	1.5K
LFEC1E-5Q208C	112	-5	PQFP	208	COM	1.5K
LFEC1E-3T144C	97	-3	TQFP	144	COM	1.5K
LFEC1E-4T144C	97	-4	TQFP	144	COM	1.5K
LFEC1E-5T144C	97	-5	TQFP	144	COM	1.5K
LFEC1E-3T100C	67	-3	TQFP	100	COM	1.5K
LFEC1E-4T100C	67	-4	TQFP	100	COM	1.5K
LFEC1E-5T100C	67	-5	TQFP	100	COM	1.5K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC3E-3F256C	160	-3	fpBGA	256	COM	3.1K
LFEC3E-4F256C	160	-4	fpBGA	256	COM	3.1K
LFEC3E-5F256C	160	-5	fpBGA	256	COM	3.1K
LFEC3E-3Q208C	145	-3	PQFP	208	COM	3.1K
LFEC3E-4Q208C	145	-4	PQFP	208	COM	3.1K
LFEC3E-5Q208C	145	-5	PQFP	208	COM	3.1K
LFEC3E-3T144C	97	-3	TQFP	144	COM	3.1K
LFEC3E-4T144C	97	-4	TQFP	144	COM	3.1K
LFEC3E-5T144C	97	-5	TQFP	144	COM	3.1K
LFEC3E-3T100C	67	-3	TQFP	100	COM	3.1K
LFEC3E-4T100C	67	-4	TQFP	100	COM	3.1K
LFEC3E-5T100C	67	-5	TQFP	100	COM	3.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC6E-3F484C	224	-3	fpBGA	484	COM	6.1K
LFEC6E-4F484C	224	-4	fpBGA	484	COM	6.1K
LFEC6E-5F484C	224	-5	fpBGA	484	COM	6.1K
LFEC6E-3F256C	195	-3	fpBGA	256	COM	6.1K
LFEC6E-4F256C	195	-4	fpBGA	256	COM	6.1K
LFEC6E-5F256C	195	-5	fpBGA	256	COM	6.1K
LFEC6E-3Q208C	147	-3	PQFP	208	COM	6.1K
LFEC6E-4Q208C	147	-4	PQFP	208	COM	6.1K
LFEC6E-5Q208C	147	-5	PQFP	208	COM	6.1K
LFEC6E-3T144C	97	-3	TQFP	144	COM	6.1K
LFEC6E-4T144C	97	-4	TQFP	144	COM	6.1K
LFEC6E-5T144C	97	-5	TQFP	144	COM	6.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC10E-3F484C	288	-3	fpBGA	484	COM	10.2K
LFEC10E-4F484C	288	-4	fpBGA	484	COM	10.2K
LFEC10E-5F484C	288	-5	fpBGA	484	COM	10.2K
LFEC10E-3F256C	195	-3	fpBGA	256	COM	10.2K

LatticeECP Commercial

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP6E-3FN484C	224	-3	Lead-Free fpBGA	484	COM	6.1K
LFCEP6E-4FN484C	224	-4	Lead-Free fpBGA	484	COM	6.1K
LFCEP6E-5FN484C	224	-5	Lead-Free fpBGA	484	COM	6.1K
LFCEP6E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	6.1K
LFCEP6E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	6.1K
LFCEP6E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	6.1K
LFCEP6E-3QN208C	147	-3	Lead-Free PQFP	208	COM	6.1K
LFCEP6E-4QN208C	147	-4	Lead-Free PQFP	208	COM	6.1K
LFCEP6E-5QN208C	147	-5	Lead-Free PQFP	208	COM	6.1K
LFCEP6E-3TN144C	97	-3	Lead-Free TQFP	144	COM	6.1K
LFCEP6E-4TN144C	97	-4	Lead-Free TQFP	144	COM	6.1K
LFCEP6E-5TN144C	97	-5	Lead-Free TQFP	144	COM	6.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP10E-3FN484C	288	-3	Lead-Free fpBGA	484	COM	10.2K
LFCEP10E-4FN484C	288	-4	Lead-Free fpBGA	484	COM	10.2K
LFCEP10E-5FN484C	288	-5	Lead-Free fpBGA	484	COM	10.2K
LFCEP10E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	10.2K
LFCEP10E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	10.2K
LFCEP10E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	10.2K
LFCEP10E-3QN208C	147	-3	Lead-Free PQFP	208	COM	10.2K
LFCEP10E-4QN208C	147	-4	Lead-Free PQFP	208	COM	10.2K
LFCEP10E-5QN208C	147	-5	Lead-Free PQFP	208	COM	10.2K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP15E-3FN484C	352	-3	Lead-Free fpBGA	484	COM	15.3K
LFCEP15E-4FN484C	352	-4	Lead-Free fpBGA	484	COM	15.3K
LFCEP15E-5FN484C	352	-5	Lead-Free fpBGA	484	COM	15.3K
LFCEP15E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	15.3K
LFCEP15E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	15.3K
LFCEP15E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	15.3K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP20E-3FN672C	400	-3	Lead-Free fpBGA	672	COM	19.7K
LFCEP20E-4FN672C	400	-4	Lead-Free fpBGA	672	COM	19.7K
LFCEP20E-5FN672C	400	-5	Lead-Free fpBGA	672	COM	19.7K
LFCEP20E-3FN484C	400	-3	Lead-Free fpBGA	484	COM	19.7K
LFCEP20E-4FN484C	400	-4	Lead-Free fpBGA	484	COM	19.7K
LFCEP20E-5FN484C	400	-5	Lead-Free fpBGA	484	COM	19.7K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP33E-3FN672C	496	-3	Lead-Free fpBGA	672	COM	32.8K
LFCEP33E-4FN672C	496	-4	Lead-Free fpBGA	672	COM	32.8K
LFCEP33E-5FN672C	496	-5	Lead-Free fpBGA	672	COM	32.8K